# imall

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# GL4910

#### Features

- 1. Small spot light diameter for easy beam diaphragming (\*Apparent emission diameter : TYP.  $\phi$  0.32 mm)
- 2. Uniform emission intensity on chip emitting surface
- 3. Low peak forward voltage type

(Peak forward voltage V FM: TYP. 1.7V)

\*Expansion range on lens surface of infrared emitted from chips

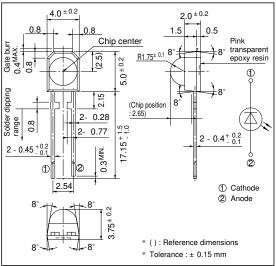
#### Applications

1. Cameras

# Side View Type Infrared Emitting Diode for Camera AF (Automatic Focusing)

Outline Dimensions

(Unit:mm)



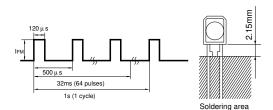
#### Absolute Maximum Ratings

(Ta=25°C)

	•		
Parameter	Symbol	Rating	Unit
Forward current	IF	50	mA
*1Peak forward current	IFM	1	А
Reverse voltage	VR	4	V
Operating temperature	Topr	- 25 to + 60	°C
Storage temperature	T <sub>stg</sub>	- 40 to + 85	°C
*2 Soldering temperature	T <sub>sol</sub>	260	°C

\*1 30,00 cycles max. on pulse conditions shown in the right drawing

\*2 For 5 seconds at the position of 2.15 mm from the resin edge



<sup>44</sup> In the absence of confirmation by device specification sheets, SHARP takes no responsibility for any defects that occur in equipment using any of SHARP's devices, shown in catalogs, data books, etc. Contact SHARP in order to obtain the latest version of the device specification sheets before using any SHARP's device."

### Electro-optical Characteristics

(Ta=25 °C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Forward voltage	VF	$I_F = 50 m A$	-	1.55	1.7	V
Peak forward voltage	V FM	$I_{FM} = 300 \text{mA}, t = 10 \text{ms}$	-	1.7	1.95	V
Reverse current	IR	$V_R = 1V$	-	-	100	μA
Radiant flux	$^{*3}\Phi_{e}$	$I_{FM} = 300 \text{mA}, t = 10 \text{ms}$	4.2	9	-	mW
Peak emission wavelength	λp	$I_F = 50 mA$	-	850	-	nm
Half intensity wavelength	Δλ	$I_F = 50 mA$	-	35	-	nm
Half intensity angle	Δθ	$I_F = 50 mA$	-	± 32	-	٥
Terminal capacitance	Ct	$V_{R} = 0, f = 1MH_{Z}$	-	80	-	pF

\*3 Emission output to effective angle  $\pm 25^{\circ}$ 

Fig. 1 Forward Current vs. Ambient Temperature

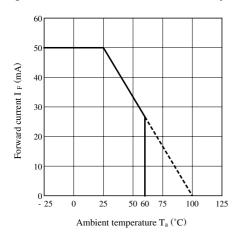
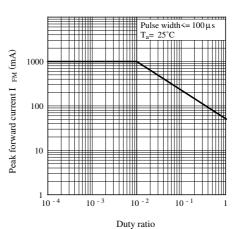


Fig. 2 Peak Forward Current vs. Duty Ratio



#### Fig. 3 Spectral Distribution

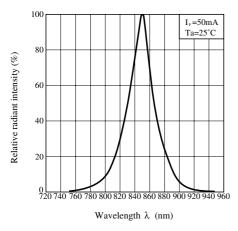
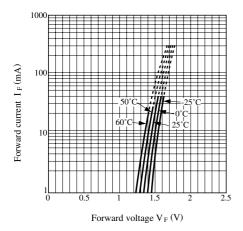
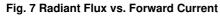


Fig. 5 Forward Current vs. Forward Voltage





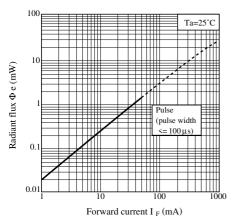
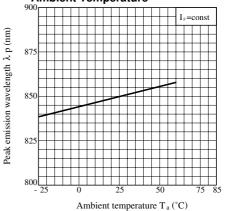
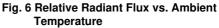
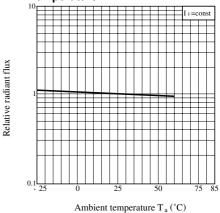
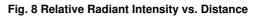


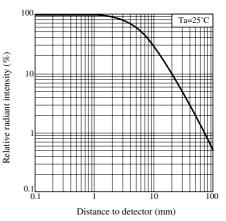
Fig. 4 Peak Emission Wavelength vs. Ambient Temperature



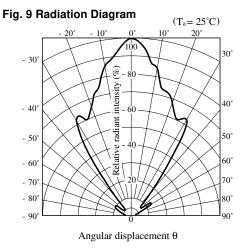








### SHARP



• Please refer to the chapter "Precautions for Use". (Page 78 to 93)

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  - Telecommunication equipment [terminal]
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  - Industrial control
  - Audio visual equipment
  - Consumer electronics

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- Alarm equipment
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